LCD MOUDULE SPECIFICATION FOR APPROVAL	DATE	18/03/04
	VER.	1.0
JHD162A	PAGE	1

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- Display type····················· Positive Transflective
- Backlight························· LED(B/5.0V)
- Viewing direction················ 6 o'clock
- Operating temperature············ Indoor
- Driving voltage·················· Single power
- Driving method··················· 1/16 duty,1/5 bias
- Type····························· COB (Chip On Board)
- Number of data line·············· 8-bit parallel
- Connector························ Pin

2. MECHANICAL DATA

ITEM		WIDTH	HEIGHT	THICKNESS	UNIT
Module size		80.0	36.0	14.0(MAX)	mm
Viewing area		73.8	27.1	–	mm
character	Construction	5*7			dots
	Size	2.95	4.35	–	mm
	Pitch	3.65	5.05	–	mm
Dot	Size	0.55	0.5	–	mm
	Pitch	0.6	0.55	–	mm
Diameter of mounting hole		2.7			mm
Weight		About 50			g

3. ABSOLUTE MAXIMUM RATINGS

Characteristics	Symbol	Ratings
Operating Voltage	VDD	-0.3V to +7.0V
Driver Supply Voltage	V_{LCD}	VDD-12V to VDD+0.3V
Input Voltage Range	V_{IN}	-0.3V to VDD + 0.3V
Operating Temperature	T_A	0℃~+60 ℃
Storage Temperature	T_{STO}	-55℃~+125 ℃

4. ELECTRICAL CHARACTERISTICS

(TA = 25 , VDD = 2.7 to 4.5V)

Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
Operating Current	I_{DD}	-	0.2	0.4	mA	External clock (Note)
Input High Voltage	V_{IH1}	0.7VDD	-	VDD	V	Pins:(E, RS, R/W, DB7 - 0)
Input Low Voltage	V_{IL1}	-0.3	-	0.55	V	
Input High Voltage	V_{IH2}	0.7VDD	-	VDD	V	Pin OSC1
Input Low Voltage	V_{IL2}	-0.2	-	0.2VDD	V	
Input High Current	I_{IH}	-1.0	-	1.0	μA	Pins: (RS, R/W, DB7 - 0)
Input Low Current	I_{IL}	-5.0	-15	-30	μA	VDD = 3.0V
Output High Voltage (TTL)	V_{OH1}	0.75VDD	-	-	V	I_{OH} = - 0.1mA Pins: DB7 - 0
Output Low Voltage (TTL)	V_{OL1}	-	-	0.2VDD	V	I_{OL} = 0.1mA Pins: DB7 - 0
Output High Voltage (CMOS)	V_{OH2}	0.8VDD	-	-	V	I_{OH} = - 40μA, Pins: CL1, CL2, M, D
Output Low Voltage (CMOS)	V_{OL2}	-	-	0.2VDD	V	I_{OL} = 40μA, Pins: CL1, CL2, M, D
Driver ON Resistance (COM)	R_{COM}	-	-	20	KΩ	I_O = ±50μA, V_{LCD} = 4V Pins: COM16 - 1
Driver ON Resistance (SEG)	R_{SEG}	-	-	30	KΩ	I_O = ±50μA, V_{LCD} = 4V Pins: SEG40 - 1
LCD Voltage	V_{LCD}	3.0	-	11.0	V	VDD-V5, 1/4 bias or 1/5 bias

5. ELECTRO-OPTICAL CHARACTERISTICS

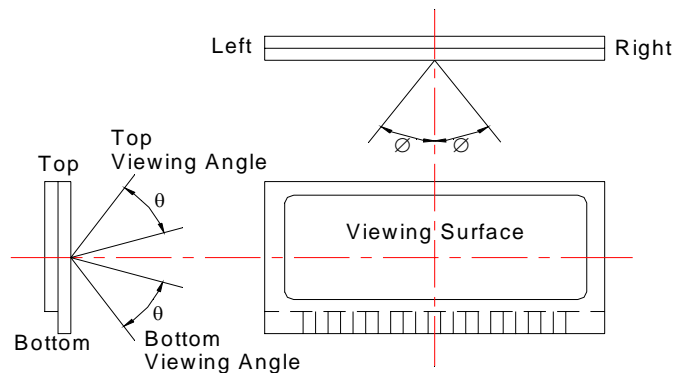| ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	NOTE
Contrast ratio	K	$\phi=0$	1.4	4	–	–	1
Response time (rise)	Tr	$\phi=1$	–	130	–	ms	2
Response time (fall)	Tf	$\phi=2$		130	–	ms	2
Viewing angle	ϕ	K $\geqslant$1.4	10 -- +30			deg.	3
	θ		-30 -- +30				

Note 1: Definition of Contrast Ratio "K"

$$K= \frac{\text{Brightness of non-selected segment(A)}}{\text{Brightness of selected segment(B)}}$$
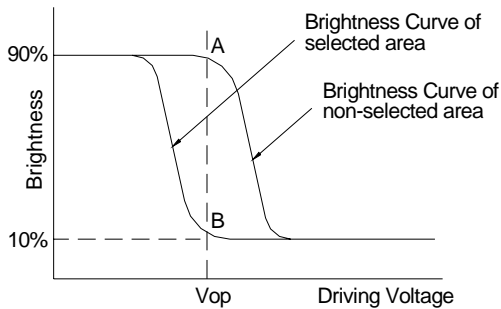
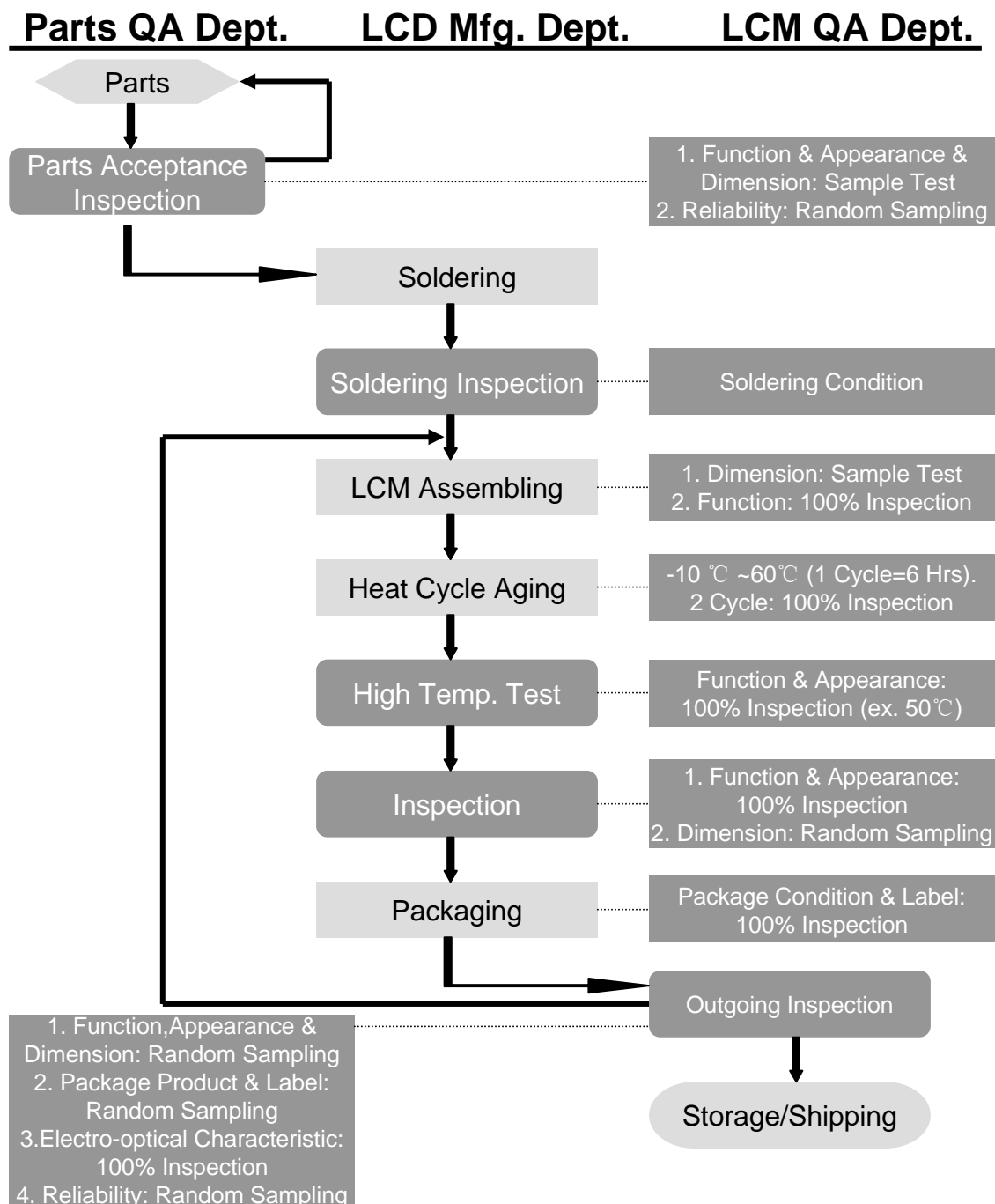## Note 2: Definition of Optical Response Time
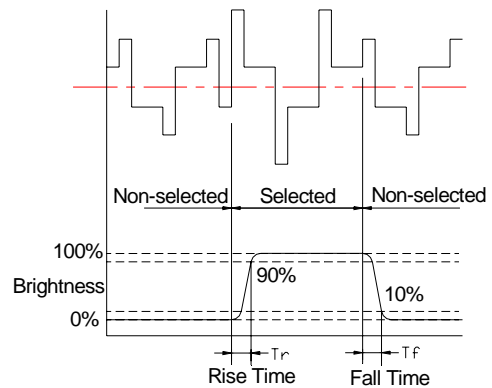
Note 3: Definition of Viewing Angle

Please select either top or bottom viewing angle

6. QC/QA PROCEDURE

Parts QA Dept.	LCD Mfg. Dept.	LCM QA Dept.

Parts

Parts Acceptance Inspection

1. Function & Appearance & Dimension: Sample Test
2. Reliability: Random Sampling

Soldering

Soldering Inspection

Soldering Condition

LCM Assembling

1. Dimension: Sample Test
2. Function: 100% Inspection

Heat Cycle Aging

-10 ℃ ~60℃ (1 Cycle=6 Hrs). 2 Cycle: 100% Inspection

High Temp. Test

Function & Appearance: 100% Inspection (ex. 50℃)

Inspection

1. Function & Appearance: 100% Inspection
2. Dimension: Random Sampling

Packaging

Package Condition & Label: 100% Inspection

Outgoing Inspection

1. Function,Appearance & Dimension: Random Sampling
2. Package Product & Label: Random Sampling
3.Electro-optical Characteristic: 100% Inspection
4. Reliability: Random Sampling
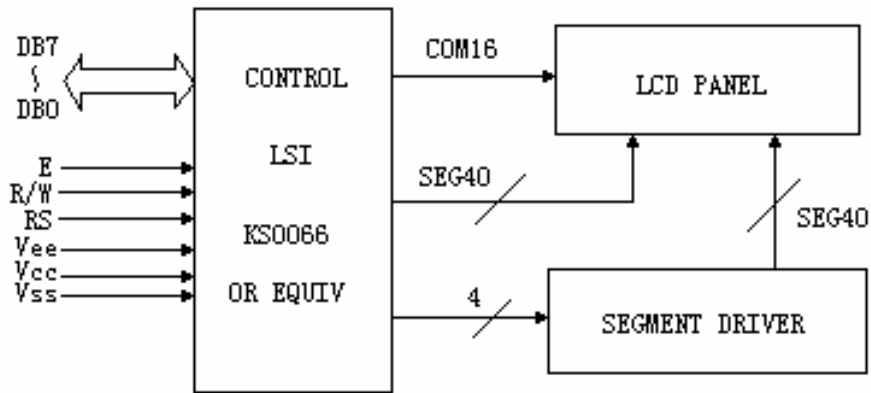
Storage/Shipping

7. RELIABILITY

• Operating life time:

Longer than 50000 hours (at room temperature without direct irradiation of sunlight)
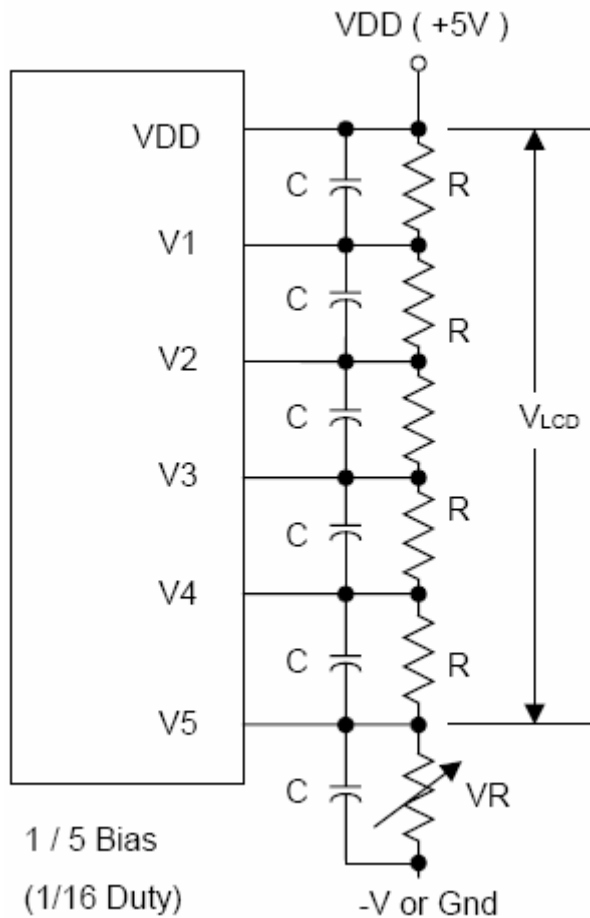
• Reliability Characteristics:

Item	Test	Criterion
High temp	60℃ / 200 Hrs	■Total current consumption should be below double of initial value ■Contrast ratio should be within initial value±50% ■No defect in cosmetic and operational function is allowable
Low temp.	−10℃ / 200 Hrs	
High humidity	40℃ * 90%RH / 200 Hrs	
Thermal shock	−10℃→25℃→60℃→25℃ /5 Cycles (30min) (5min) (30min) (5min)	
Vibration	1.Operating time: Thirty minutes exposure in each direction (x, y, z) 2.Sweep Frequency (1min):10Hz→ 55Hz →10Hz 3.Amplitude: 0.75mm double amplitude	

8. BLOCK DIAGRAM

9. POWER SUPPLY

10. TIMING DIAGRAM

- WRITE OPERATION

- READ OPERATION

11. AC CHARACTERISTICS

• WRITE MODE

Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_C	1000	-	-	ns	Pin E
E Pulse Width	t_{PW}	450	-	-	ns	Pin E
E Rise/Fall Time	t_R, t_F	-	-	25	ns	Pin E
Address Setup Time	t_{SP1}	60	-	-	ns	Pins: RS, R/W, E
Address Hold Time	t_{HD1}	20	-	-	ns	Pins: RS, R/W, E
Data Setup Time	t_{SP2}	195	-	-	ns	Pins: DB7 - 0
Data Hold Time	t_{HD2}	10	-	-	ns	Pins: DB7 - 0

• READ MODE

Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_C	1000	-	-	ns	Pin E
E Pulse Width	t_W	450	-	-	ns	Pin E
E Rise/Fall Time	t_R, t_F	-	-	25	ns	Pin E
Address Setup Time	t_{SP1}	60	-	-	ns	Pins: RS, R/W,E
Address Hold Time	t_{HD1}	20	-	-	ns	Pins: RS, R/W,E
Data Output Delay Time	t_D	-	-	360	ns	Pins: DB7 - 0
Data hold time	t_{HD2}	5.0	-	-	ns	Pin DB7 - 0

12. INITIALIZATION SEQUENCE

[4-Bit Interface]

Power On

Wait time > 15 ms
after VDD > 4.5V

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	1

BF cannot be checked before this instruction .

Function set (Interface is 8 bits length .)

Wait time > 4.1 ms

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	1

BF cannot be checked before this instruction .

Function set (Interface is 8 bits length .)

Wait time > 100 us

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	1

BF cannot be checked before this instruction .

Function set (Interface is 8 bits length .)

BF can be checked after the following instructions .

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	0
0	0	0	0	1	0
0	0	N	F	X	X
0	0	0	0	0	0
0	0	1	0	0	0
0	0	0	0	0	0
0	0	0	0	0	1
0	0	0	0	0	0
0	0	0	1	I/D	S

Function set (Set interface to be 4 bits length)
Interface is 8 bits length .

Function set (Interface is 4 bits length .
Specify the number of the display lines
and character font .)

The number of display lines and character
font cannot be changed afterwards .

Display off

Display clear

Entry mode set

Initialization Ends

13. INSTRUCTION SET

COMMAND	COMMAND CODE										COMMAND CODE	E-CYCLE f_{osc}=250KHz
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
SCREEN CLEAR	0	0	0	0	0	0	0	0	0	1	Screen Clear, Set AC to 0 Cursor Reposition	1.64ms
CURSOR RETURN	0	0	0	0	0	0	0	0	1	*	DDRAM AD=0, Return, Content Changeless	1.64ms
INPUT SET	0	0	0	0	0	0	0	1	I/D	S	Set moving direction of cursor, Appoint if move	40us
DISPLAY SWITCH	0	0	0	0	0	0	1	D	C	B	Set display on/off,cursor on/off, blink on/off	40us
SHIFT	0	0	0	0	0	1	S/C	R/L	*	*	Remove cursor and whole display,DDRAM changeless	40us
FUNCTION SET	0	0	0	0	1	DL	N	F	*	*	Set DL,display line,font	40us
CGRAM AD SET	0	0	0	1	ACG						Set CGRAM AD, send receive data	40us
DDRAM AD SET	0	0	1	ADD							Set DDRAM AD, send receive data	40us
BUSY/AD READ CT	0	1	BF	AC							Executing internal function, reading AD of CT	40us
CGRAM/ DDRAM DATA WRITE	1	0	DATA WRITE								Write data from CGRAM or DDRAM	40us
CGRAM/ DDRAM DATA READ	1	1	DATA READ								Read data from CGRAM or DDRAM	40us
	I/D=1: Increment Mode; I/D=0: Decrement Mode S=1: Shift S/C=1: Display Shift; S/C=0: Cursor Shift R/L=1: Right Shift; R/L=0: Left Shift DL=1: 8D DL=0: 4D N=1: 2R N=0: 1R F=1: 5x10 Style; F=0: 5x7 Style BF=1: Execute Internal Function; BF=0: Command Received										DDRAM: Display data RAM CGRAM: Character Generator RAM ACG: CGRAM AD ADD: DDRAM AD & Cursor AD AC: Address counter for DDRAM & CGRAM	E-cycle changing with main frequency. Example: If fcp or f_{osc}=270KHz 40us x 250/270 =37us

14. FONT TABLE

b7-b4 / b3-b0	0000	0010	0011	0100	0101	0110	0111	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)		0	@	P	`	p		―	タ	ミ	α	p
0001	(2)	!	1	A	Q	a	q	。	ア	チ	ム	ä	q
0010	(3)	"	2	B	R	b	r	「	イ	ツ	メ	β	θ
0011	(4)	#	3	C	S	c	s	」	ウ	テ	モ	ε	∞
0100	(5)	$	4	D	T	d	t	、	エ	ト	ヤ	μ	Ω
0101	(6)	%	5	E	U	e	u	・	オ	ナ	ユ	σ	Ü
0110	(7)	&	6	F	V	f	v	ヲ	カ	ニ	ヨ	ρ	Σ
0111	CG RAM (8)	'	7	G	W	g	w	ア	キ	ヌ	ラ	g	π
1000	CG RAM (1)	(	8	H	X	h	x	ィ	ク	ネ	リ	√	x̄
1001	(2)	)	9	I	Y	i	y	ゥ	ケ	ノ	ル	⁻¹	y
1010	(3)	*	:	J	Z	j	z	ェ	コ	ハ	レ	j	千
1011	(4)	+	;	K	[	k	{	ォ	サ	ヒ	ロ	×	万
1100	(5)	,	<	L	¥	l			ャ	シ	フ	ワ	¢	円
1101	(6)	-	=	M	]	m	}	ュ	ス	ヘ	ン	£	÷
1110	(7)	.	>	N	^	n	→	ョ	セ	ホ	˝	ñ	
1111	CG RAM (8)	/	?	O	_	o	←	ッ	ソ	マ	°	ö	▓

15. Handling Precautions

1. Limitation of Application:
Optrex products are designed for use in ordinary electronic devices such as business machines, telecommunications equipment,measurement devices and etc. Please handle the products with care. (see below)
Optrex products are not designed,intended ,or authorized for use in any application which the failure of the product could result in a situation where personal injury or death may occur . these applications include, but are not limited to . life-sustaining equipment,nuclear control devices , aerospace equipment , devices related to hazardous or flammable materials , etc.[If Buyer intends to purchase or use the Optrex Products for such unintended or unauthorized applications , Buyer must secure prior written consent to such use by a responsible officer of Optrex Corporation.]Should Buyer purchase or use Optrex Products for any such unintended or unauthorized application [without such consent].Buyer shall indemnify and hold Optrex and its officers. employees. subsidiaries, affiliates and distributors harmless against all claims, costs, damages and expenses , and reasonable attorney's fees,arising out of , directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Optrex was negligent regarding the design or manufacture of the part.
2.Industrial Rights and Patents
Optrex shall not be responsible for any infringement of industrial property rights of third parties in any country arising out of the application or use of Optrex products, except which directly concern the structure or production of such products.

No Press and Shock!

If pressure to LCD, orientation may be disturbed.
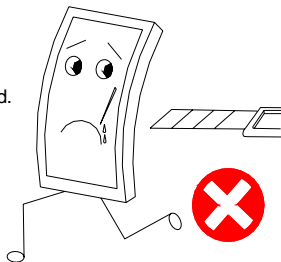LCD will broken by shock!
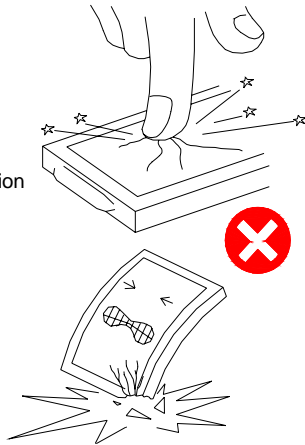
Don't Swallow or Touch Liquid Crystal!

Liquid Crystal may be leaked when display is broked.
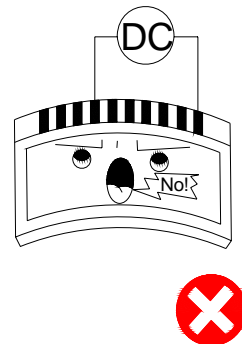If it accidentally gets your hands, wash then with water!
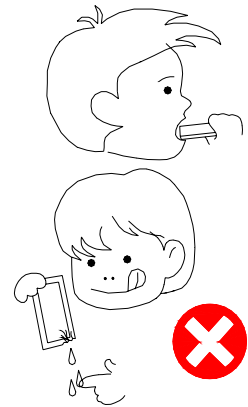
Don't not Scratch!

Polarizer is a soft material and can easily be scratched.
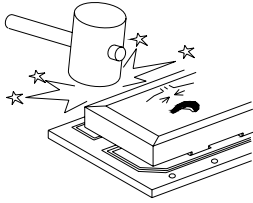
No DC Voltage to LCD!

DC volrage or driveing higher than the specified voltage will reduce the lifetime of the LCD.
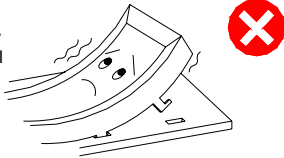
Don't Press the Metallic Frame and Disassemble the LCM

Pressure on the metallic frame and PCB may deform the conductive rubber or break the liquid crystal cell and back light, which will cause defects.
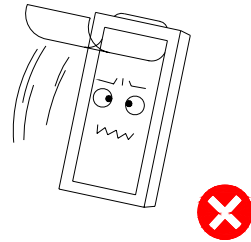
LCD may be shifted or conductive rubber may be reshaped, which will cause defects.
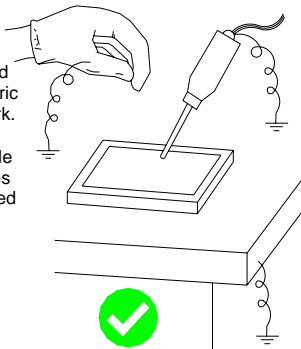
Slowly Peel Off Protective Film!

Avoid static electricity.

Avoid Static Electricity!

Please be sure to ground human body and electric apploances during work.

It is preferable to use conductive mat on table and wear cotton clothes or conduction processed fiber. Synthetic fiber is not recommended.
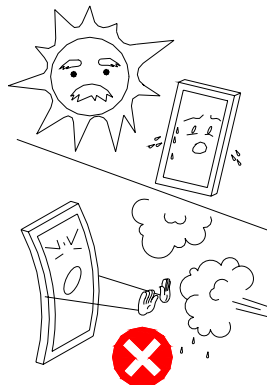
Wear Gloves While Handing!

It is preferable to wear gloves to avoid damaging the LCD.

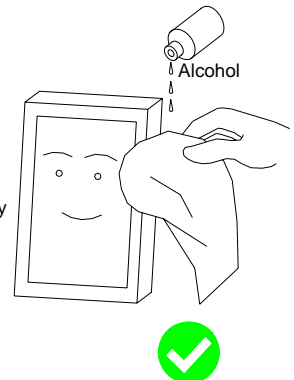Please do not touch electrodes with bare hands or make them dirty.

GLOVE
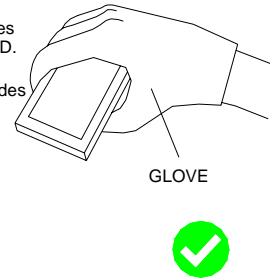
Keep Away From Extreme Heat and Humidity!
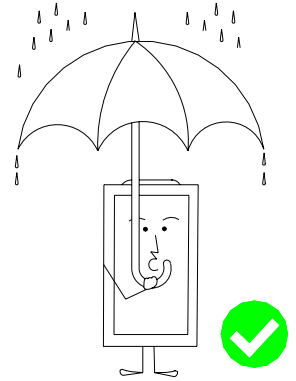
LCD deteriorates.

Use Alcohol to Clean Terminals!

Alcohol

When attaching with the heat seal or anisotropically conductive film, wipe off with alcohol before use.

Don't Drop Water on LCD!

Note that the presence of waterdrops or dew in the LCD panel may deteriorate the polarizer or corrade electrode.

Precaution in Soldering LCD Module

Basic instructions: Solder I/O terminals only.
Use soldering iron without leakage.
(1)Soldering condition to I/O terminals
   Temperature at tip of the iron: 280±10℃
   Soldering time: 3~4 sec.
   Type of solder: Eutectic solder (containing colophony-flux)
  *Please do not use flux because it may soak into LCD Module or contaminate it.
  *It is preferable to peel off protective film on display surface after soldering I/O
   terminals is finished.
(2)Remove connector or cable
  *When you remove connector or cable soldered to I/O terminals, please confirm
   that solder is fully melted. If you remove by force, electrodes at I/O terminals may
   be damaged(or stripped off).
  *It is recommended to use solder suction machine.

Long-term Storage

If it is necessary to store LCD modules for a long time, please comply with the
following procedures.
If storage condition is not satisfactory, display(especially polarizer) may be deteriorated
or soldering I/O terminals may become difficult(some oxide is generated at I/O
terminals plating).
1.Store as delivered by Optrex
2.If you store as unpacked,put in anti-static bag,seal its opening and store where it is
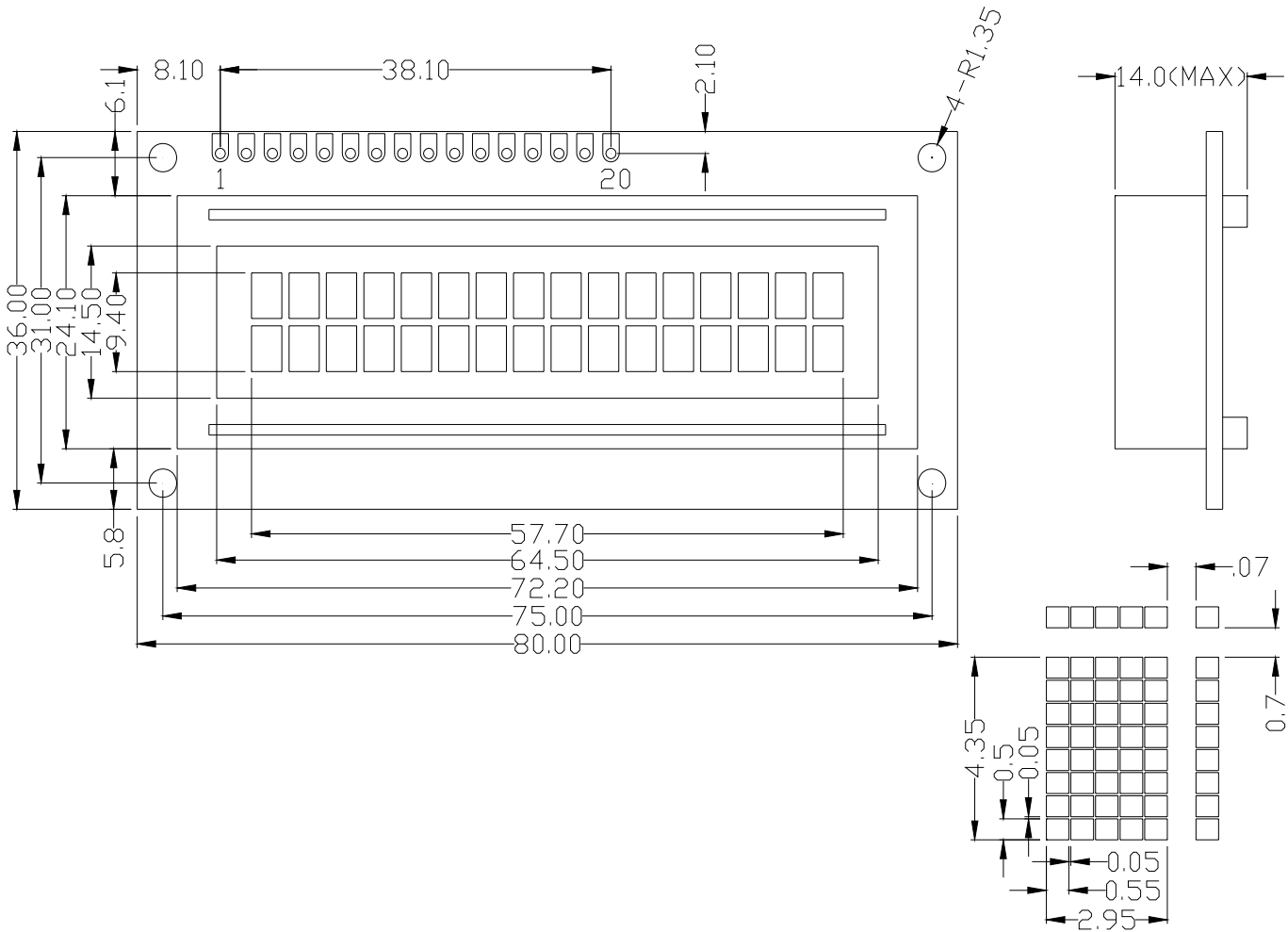 not subjected to direct sunshine nor fluorescent lamp.
3.Store at temperature 0 to +35℃ and at low humidity.Please refer to our specification
  sheets for storage temperature range and humidity condition.

Long-term Storage

Please use power supply with built-in surge protection circuit.

16. EXTERNAL DIMENSION

1	2	3	4	5	6	7	8
VSS	VCC	VEE	RS	R/W	E	DB0	DB1
9	10	11	12	13	14	15	16
DB2	DB3	DB4	DB5	DB6	DB7	LED+	LED-

17. INTERFACE

PIN NO.	SYMBOL	DESCRIPTION	FUNCTION
1	VSS	GROUND	0V (GND)
2	VCC	POWER SUPPLY FOR LOGIC CIRCUIT	+5V
3	VEE	LCD CONTRAST ADJUSTMENT	
4	RS	INSTRUCTION/DATA REGISTER SELECTION	RS = 0 : INSTRUCTION REGISTER RS = 1 : DATA REGISTER
5	R/W	READ/WRITE SELECTION	R/W = 0 : REGISTER WRITE R/W = 1 : REGISTER READ
6	E	ENABLE SIGNAL	
7	DB0	DATA INPUT/OUTPUT LINES	8 BIT: DB0-DB7
8	DB1		
9	DB2		
10	DB3		
11	DB4		
12	DB5		
13	DB6		
14	DB7		
15	LED+	SUPPLY VOLTAGE FOR LED+	+5V
16	LED-	SUPPLY VOLTAGE FOR LED-	0V